



# MOSFET

# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V

### **Features**

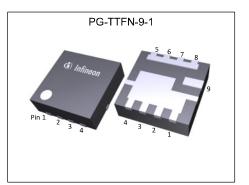
- Optimized for synchronous rectification
- 100% avalanche testedSuperior thermal resistance
- N-channel, normal level
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

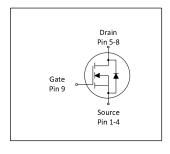
# **Product validation**

Fully qualified according to JEDEC for Industrial Applications

#### Table 1 **Key Performance Parameters**

Parameter	Value	Unit
V <sub>DS</sub>	60	V
RDS(on),max	3.0	mΩ
ID	137	A
Q <sub>oss</sub>	42	nC
Q <sub>G</sub> (0V10V)	39	nC









Type / Ordering Code	Package	Marking	Related Links
IQE030N06NM5CG	PG-TTFN-9-1	03006C5	-



# **Table of Contents**

Description	1
Maximum ratings	3
Thermal characteristics	3
Electrical characteristics	4
Electrical characteristics diagrams	3
Package Outlines	)
Revision History	2
Trademarks	2
Disclaimer	2



# **1 Maximum ratings** at *T*<sub>A</sub>=25 °C, unless otherwise specified

### Table 2Maximum ratings

Deveryor	C. makes		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>			137 97 21	A	$V_{GS}$ =10 V, $T_{C}$ =25 °C $V_{GS}$ =10 V, $T_{C}$ =100 °C $V_{GS}$ =10V, $T_{A}$ =25°C, $R_{thJA}$ =60°C/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	547	А	<i>T</i> <sub>A</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	EAS	-	-	153	mJ	I <sub>D</sub> =20 A, R <sub>GS</sub> =25 Ω
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	107 2.5	w	$T_{\rm C}=25 \ ^{\circ}{\rm C}$ $T_{\rm A}=25 \ ^{\circ}{\rm C}, \ R_{\rm thJA}=60 \ ^{\circ}{\rm C/W}^{2)}$
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

#### 2 **Thermal characteristics**

#### Table 3 **Thermal characteristics**

Deveneter	Values				linit	Note / Toot Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case, bottom	R <sub>thJC</sub>	-	-	1.4	°C/W	-
Device on PCB, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	60	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. <sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 μm thick) copper area for drain

connection. PCB is vertical in still air.

See Diagram 3 for more detailed information

<sup>&</sup>lt;sup>4)</sup> See Diagram 13 for more detailed information



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

#### Table 4 **Static characteristics**

Demonstration (1997)	O	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.1	2.8	3.3	V	V <sub>DS</sub> =V <sub>GS</sub> , <i>I</i> <sub>D</sub> =50 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.5 10	1.0 100	μA	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	2.2 3.3	3.0 5.0	mΩ	V <sub>GS</sub> =10 V, <i>I</i> <sub>D</sub> =20 A V <sub>GS</sub> =6 V, <i>I</i> <sub>D</sub> =5 A
Gate resistance	R <sub>G</sub>	-	0.9	-	Ω	-
Transconductance	<b>g</b> <sub>fs</sub>	-	120	-	S	V <sub>DS</sub>  ≥2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =64 A

# Table 5Dynamic characteristics

Devementer	Cumple al	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	2900	3800	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	600	780	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	37	65	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	10	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Rise time	tr	-	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Turn-off delay time	t <sub>d(off)</sub>	-	18.8	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$
Fall time	t <sub>f</sub>	-	5.7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =3 $\Omega$

#### Table 6 Gate charge characteristics<sup>2)</sup>

Parameter	0 militad		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	12.2	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge at threshold	Q <sub>g(th)</sub>	-	8.1	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	6.8	10.2	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Switching charge	Qsw	-	10.9	-	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	39	49	nC	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.2	-	V	$V_{DD}$ =30 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	35	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	42	56	nC	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.
<sup>2)</sup> See "Gate charge waveforms" for parameter definition

# OptiMOS<sup>™</sup> 5 Power-Transistor, 60 V IQE030N06NM5CG



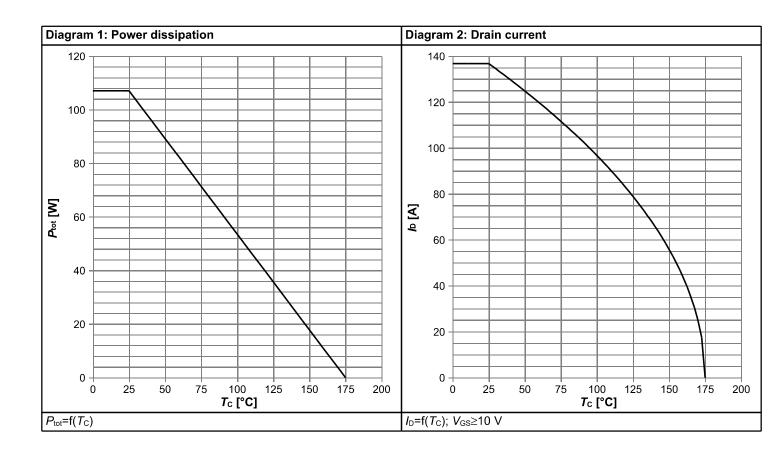
## Table 7Reverse diode

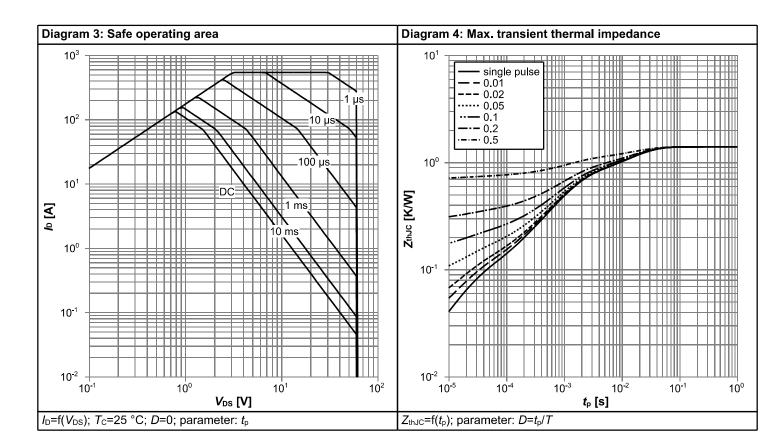
Deremeter	Symbol		Values			Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	ls	-	-	72	А	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	547	А	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.82	1.2	V	$V_{GS}=0$ V, $I_{F}=20$ A, $T_{j}=25$ °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	31	62	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs
Reverse recovery charge <sup>1)</sup>	Q <sub>rr</sub>	-	26	52	nC	V <sub>R</sub> =30 V, <i>I</i> <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.

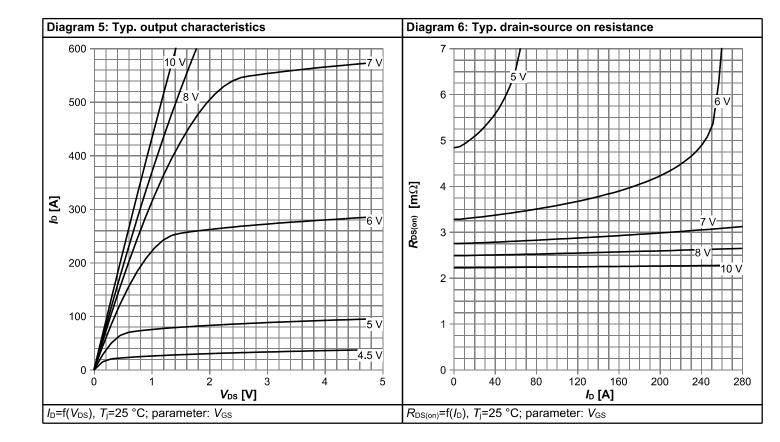


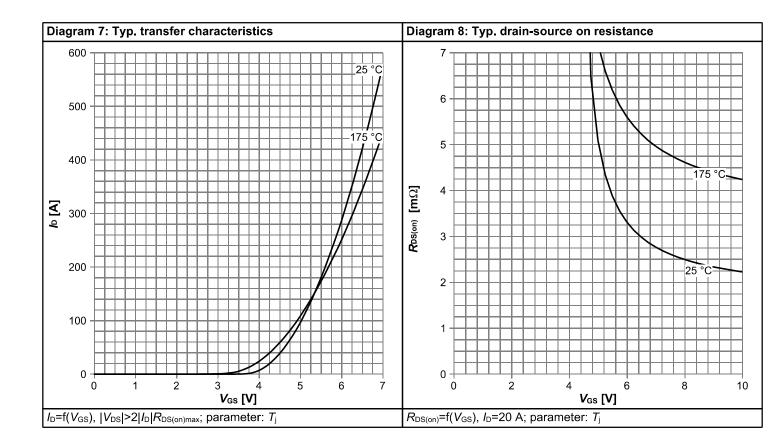
# 4 Electrical characteristics diagrams



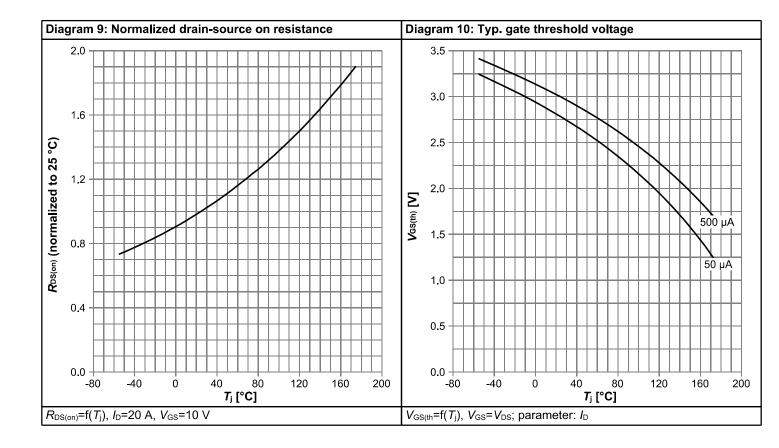


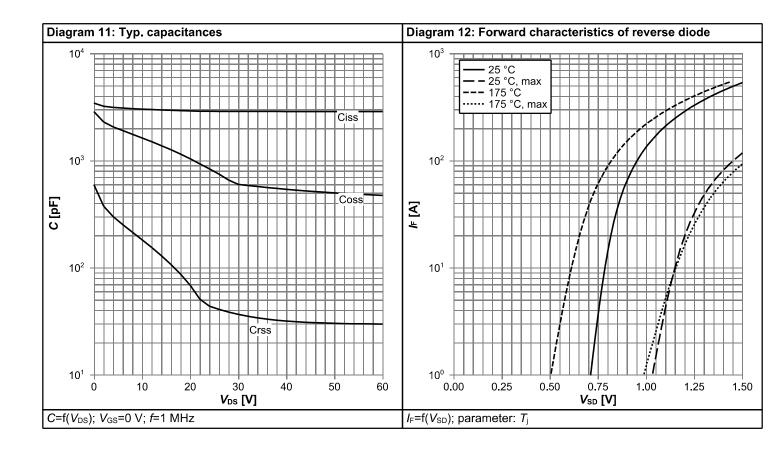




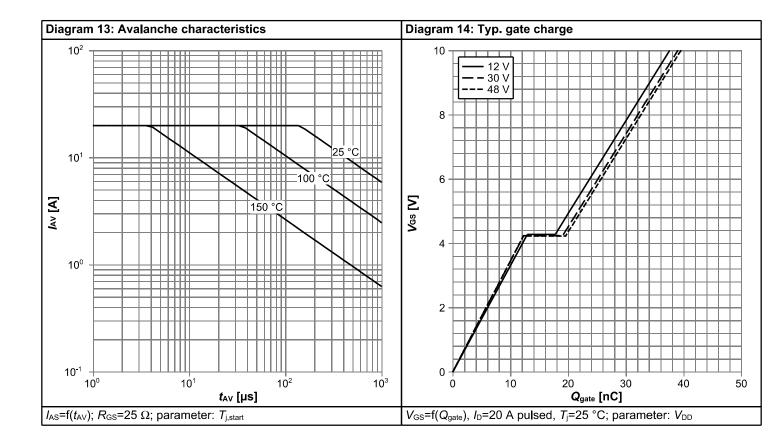


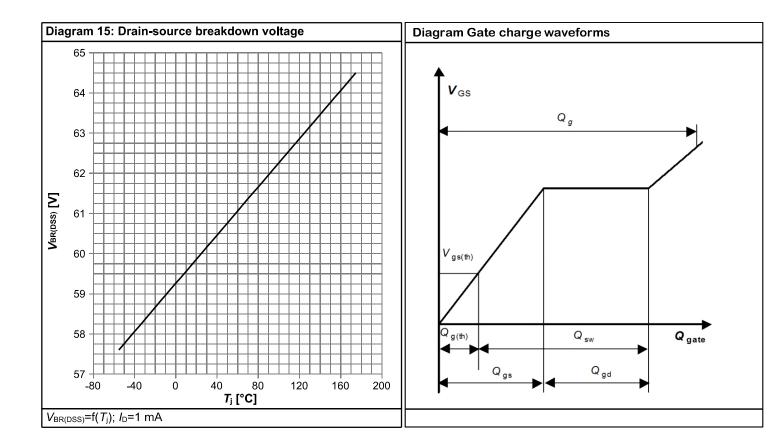






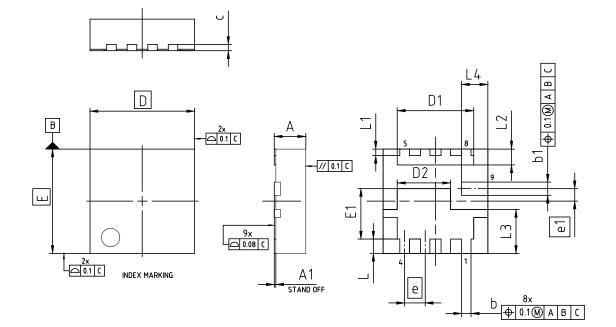




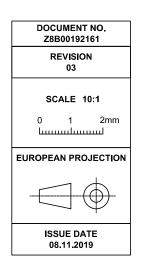




# 5 Package Outlines



DIMENSION	MILLIM	ETERS				
DIMENSION	MIN.	MAX.				
A	-	1.10				
A1	-	0.05				
b	0.20	0.40				
b1	0.32	0.52				
С	0.	20				
D	3.30					
D1	2.31	2.51				
D2	1.58	1.78				
E	3.30					
E1	1.50	1.70				
e	0.65					
e1	0.395					
L	0.35	0.55				
L1	0.10	0.30				
L2	0.40	0.60				
L3	1.285	1.485				
L4	0.73	0.93				



# Figure 1 Outline PG-TTFN-9-1, dimensions in mm



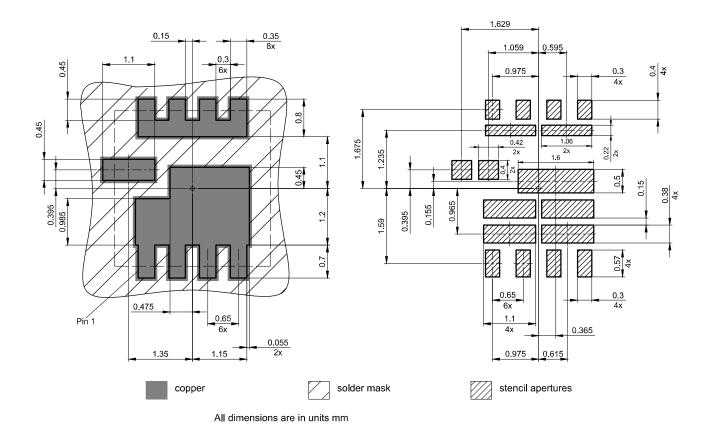


Figure 2 Outline Boardpad (PG-TTFN-9-1), dimensions in mm



## **Revision History**

IQE030N06NM5CG

### Revision: 2021-04-27, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2021-04-27	Release of final version				

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